

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2661809

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>AKIKAZU MATSUMOTO</td> <td>12/17/2013</td> </tr> <tr> <td>ERIKO SATO</td> <td>12/17/2013</td> </tr> <tr> <td>AKINORI MORINO</td> <td>12/17/2013</td> </tr> <tr> <td>KOUJIROU TANAKA</td> <td>12/17/2013</td> </tr> </tbody> </table>		Name	Execution Date	AKIKAZU MATSUMOTO	12/17/2013	ERIKO SATO	12/17/2013	AKINORI MORINO	12/17/2013	KOUJIROU TANAKA	12/17/2013
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
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OP \$40.00 14122476

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ATTORNEY DOCKET NUMBER:	131506
NAME OF SUBMITTER:	STEPHEN G. ADRIAN
Signature:	/Stephen G. Adrian/
Date:	12/27/2013

Total Attachments: 2
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source=131506_Assignment_12-27-2013#page2.tif

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by
(1) DIC Corporation of 35-58, Sakashita 3-chome, Itabashi-ku, Tokyo 174-8520 Japan;
and (2) OSAKA CITY UNIVERSITY of 3-3-138, Sugimoto, Sumiyoshi-ku, Osaka-shi,
Osaka 558-8585 Japan

(Insert ASSIGNEE's Name(s) Address(es))

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

EASILY DISMANTLABLE ADHESIVE COMPOSITION AND EASILY DISMANTLABLE ADHESIVE TAPE

(*If the assignment is being filed after the filing of the application, this section must be completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

* filed on November 26, 2013 Serial No. 14/122,476

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

<i>Akikazu Matsumoto</i>	Akikazu MATSUMOTO	December 17, 2013
(Signature)	(Type Name)	(Date)
<i>Eriko Sato</i>	Eriko SATO	December 17, 2013
(Signature)	(Type Name)	(Date)
	Akinori MORINO	
(Signature)	(Type Name)	(Date)
	Koujirou TANAKA	
(Signature)	(Type Name)	(Date)
(Signature)	(Type Name)	(Date)

NO LEGALIZATION REQUIRED

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_____	Akikazu MATSUMOTO	_____
(Signature)	(Type Name)	(Date)
_____	Eriko SATO	_____
(Signature)	(Type Name)	(Date)
<i>Akinori Morino</i>	Akinori MORINO	December 17, 2013
(Signature)	(Type Name)	(Date)
<i>Koujirou Tanaka</i>	Koujirou TANAKA	December 17, 2013
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